TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

### TC74VHC4040F,TC74VHC4040FN,TC74VHC4040FT,TC74VHC4040FK

#### 12-Stage Ripple Carry Binary Counter

The TC74VHC4040 is an advanced high speed CMOS 12-STAGE BINARY COUNTER/DIVIDER fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Setting CLR to high resets the counter to low.

A negative transition on the  $\ensuremath{\,\overline{\rm CK}\,}$  input brings one increment into the counter.

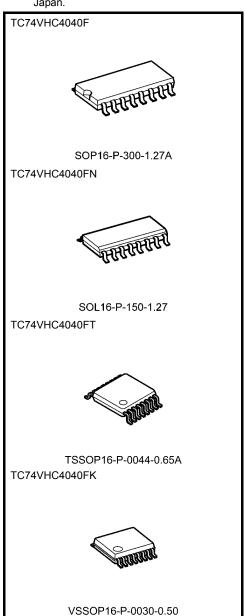
This counter provides all divided output stages, and at Q12, a 1/4096 divided frequency will be output.

An input protection circuit ensures that 0 to 5.5~V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5~V to 3~V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed:  $f_{max} = 210 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC \text{ (opr)}} = 2 \text{ V to } 5.5 \text{ V}$
- Low noise: VOLP = 1.5 V (max)
- Pin and function compatible with 74HC4040

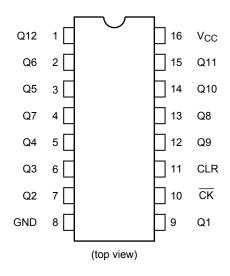
Note: xxxFN (JEDEC SOP) is not available in Japan.



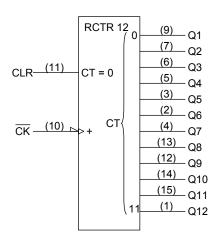
Weight

SOP16-P-300-1.27A : 0.18 g (typ.) SOL16-P-150-1.27 : 0.13 g (typ.) TSSOP16-P-0044-0.65A : 0.06 g (typ.) VSSOP16-P-0030-0.50 : 0.02 g (typ.)

## **Pin Assignment**



## **IEC Logic Symbol**



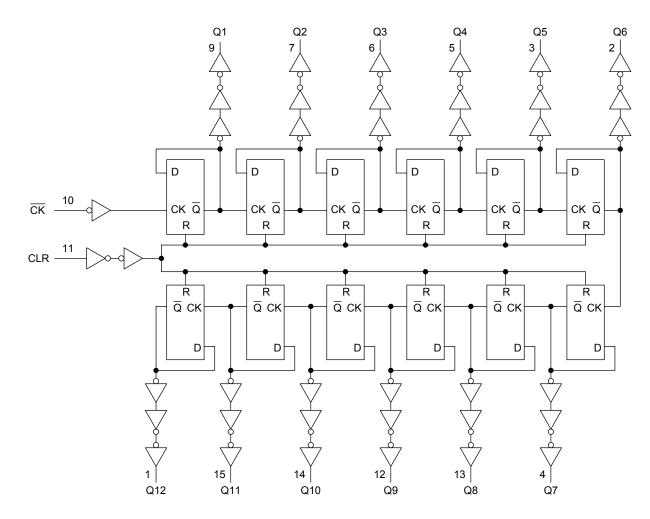
### **Truth Table**

СK	CLR	Output State
Х	Н	All Outputs = "L"
	L	No Change
$\overline{}$	L	Advance to Next State

X: Don't care

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#### **System Diagram**



### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±100	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

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Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V
input rise and rail time	ui/uv	0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	IIS/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit	
Characteriones	Cymbol				Min	Тур.	Max	Min	Max	
High-level input		-		2.0	1.50	_	_	1.50	_	V
voltage	V <sub>IH</sub>			3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	
Low-level input				2.0	_		0.50	_	0.50	
voltage	$V_{IL}$		_	3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
	Voн			2.0	1.9	2.0	_	1.9	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output voltage				4.5	4.4	4.5	_	4.4	_	V
			I <sub>OH</sub> = -4 mA	3.0	2.58	-	_	2.48	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	1	_	3.80	1	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	-	0.0	0.1	_	0.1	
			I <sub>OL</sub> = 50 μA	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	-	0.1	V
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5		-	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	-	_	±0.1	ı	±1.0	μΑ
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μΑ



### Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Test Condition			Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	t <sub>w (L)</sub>		$3.3 \pm 0.3$	_	5.0	5.0	no
( <del>CK</del> )	t <sub>w (H)</sub>	_	$5.0 \pm 0.5$	_	5.0	5.0	ns
Minimum pulse width	4		$3.3 \pm 0.3$	_	5.0	5.0	20
(CLR)	t <sub>w (H)</sub>	_	5.0 ± 0.5	_	5.0	5.0	ns
Minimum namous divino	4		$3.3 \pm 0.3$	_	5.0	5.0	20
Minimum removal time	t <sub>rem</sub>		$5.0 \pm 0.5$	_	5.0	5.0	ns

### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	T Symbol		st Condition		Ta = 25°C			Ta = −40 to 85°C		Unit	
	,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	J	
			3.3 ± 0.3	15	_	7.5	11.9	1.0	14.0	ns	
Propagation delay time	t <sub>pLH</sub>		3.3 ± 0.3	50	_	10.0	15.4	1.0	17.5		
( <del>CK</del> -Q1)	t <sub>pHL</sub>	_	5.0 ± 0.5	15	_	4.8	7.3	1.0	8.5	115	
			5.0 ± 0.5	50	_	6.3	9.3	1.0	10.5		
Propagation delay			$3.3 \pm 0.3$	50	_	2.4	4.4	_	5.0		
time $(Q_n-Q_n+1)$	Δt <sub>pd</sub>	Δt <sub>pd</sub>	_	5.0 ± 0.5	50	-	1.6	3.1	_	3.5	ns
			3.3 ± 0.3	15	_	8.3	12.8	1.0	15.0	- ns	
Propagation delay time				50	_	10.8	16.3	1.0	18.5		
(CLR-Q)	t <sub>pHL</sub>		5.0 ± 0.5	15	_	5.6	8.6	1.0	10.0		
				50	_	7.1	10.6	1.0	12.0		
			3.3 ± 0.3	15	75	140	_	75	_		
Maximum clock				50	55	80	_	50	_	MHz	
frequency	f <sub>max</sub>	_	5.0 ± 0.5	15	150	210	_	125	_	- IVIHZ	
				50	95	125	_	80	_		
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF	
Power dissipation capacitance	C <sub>PD</sub>			(Note)	_	21	_	_	_	pF	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

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Average operating current can be obtained by the equation:

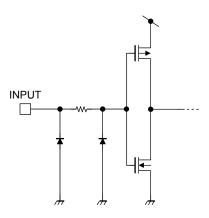
$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$



# Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta =	Ta = 25°C	
	,		V <sub>CC</sub> (V)	Тур.	Limit	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	1.2	1.5	٧
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-1.2	-1.5	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

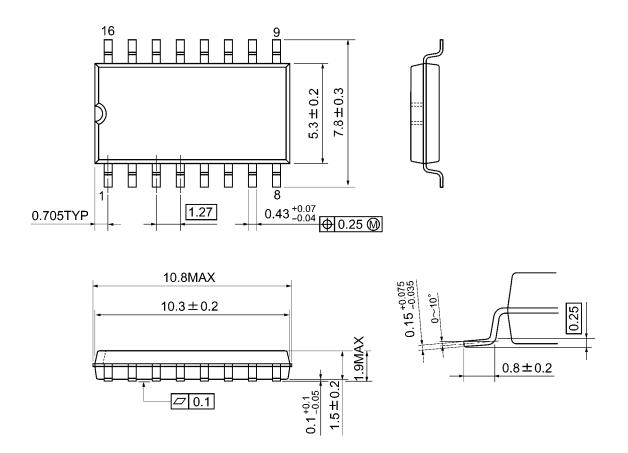
# **Input Equivalent Circuit**



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## **Package Dimensions**

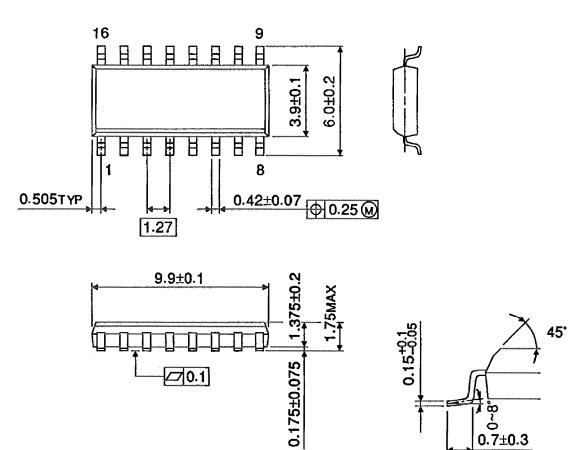
SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

## **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



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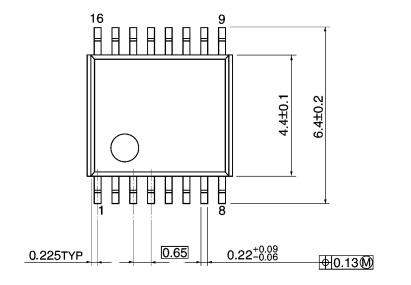
Note: This package is not available in Japan.

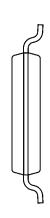
Weight: 0.13 g (typ.)

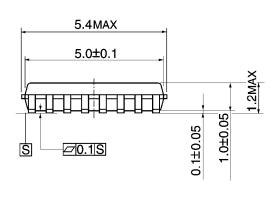
## **Package Dimensions**

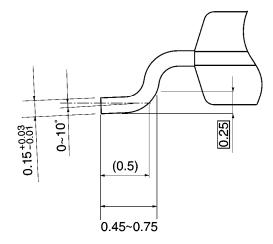
TSSOP16-P-0044-0.65A

Unit: mm







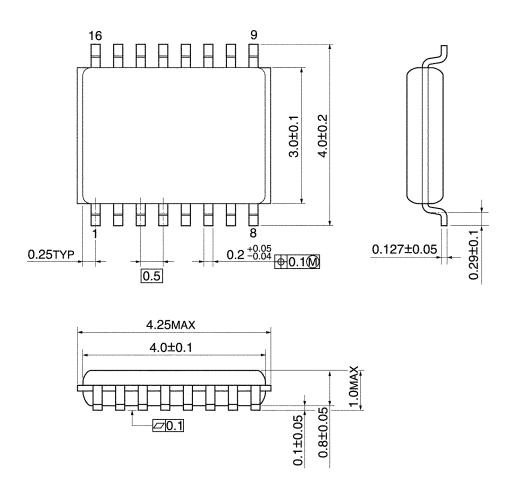


Weight: 0.06 g (typ.)

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## **Package Dimensions**

VSSOP16-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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